

PNZ158 (PN158)

Silicon planar type

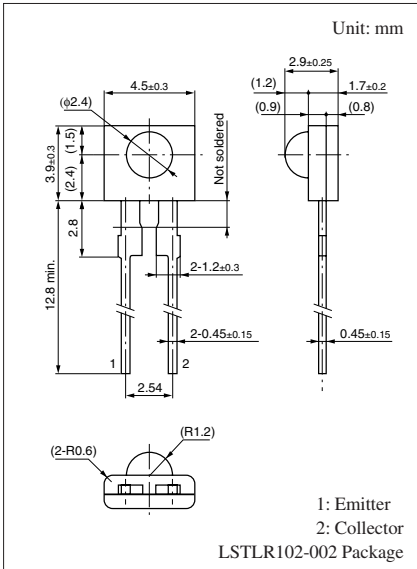
For optical control systems

■ Features

- High sensitivity
- Fast response: $t_r = 4 \mu s$ (typ.)
- Wide spectral sensitivity characteristics, suited for detecting various kinds of LEDs
- Small size, thin side-view type package

■ Absolute Maximum Ratings $T_a = 25^\circ C$

Parameter	Symbol	Rating	Unit
Collector-emitter voltage (Base open)	V_{CEO}	20	V
Emitter-collector voltage (Base open)	V_{ECO}	5	V
Collector current	I_C	20	mA
Collector power dissipation	P_C	100	mW
Operating ambient temperature	T_{opr}	-25 to +85	$^\circ C$
Storage temperature	T_{stg}	-30 to +100	$^\circ C$



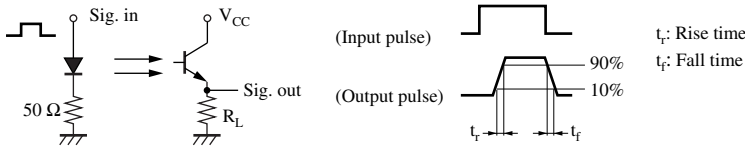
■ Electrical-Optical Characteristics $T_a = 25^\circ C \pm 3^\circ C$

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Photocurrent *1	$I_{CE(L)}$	$V_{CE} = 10 V, L = 500 lx$	1.0	4.0		μA
Dark current	I_{CEO}	$V_{CE} = 10 V$		0.01	1.00	μA
Peak sensitivity wavelength	λ_p	$V_{CE} = 10 V$		800		nm
Half-power angle	θ	The angle from which photocurrent becomes 50%		40		$^\circ$
Rise time *2	t_r	$V_{CC} = 10 V, I_{CE(L)} = 5 mA, R_L = 100 \Omega$		4	10	μs
Fall time *2	t_f			4	10	μs
Collector-emitter saturation voltage *1	$V_{CE(sat)}$	$I_{CE(L)} = 1 mA, L = 1000 lx$		0.2	0.5	V

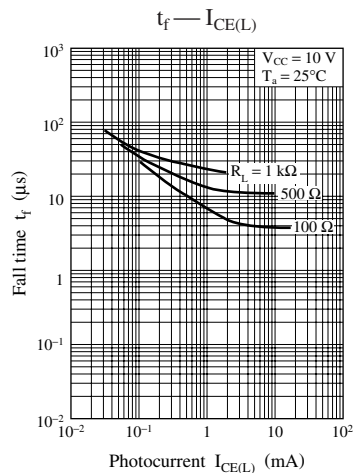
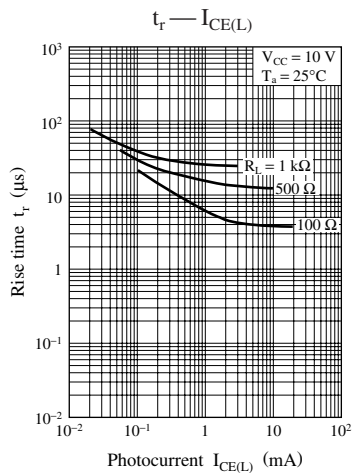
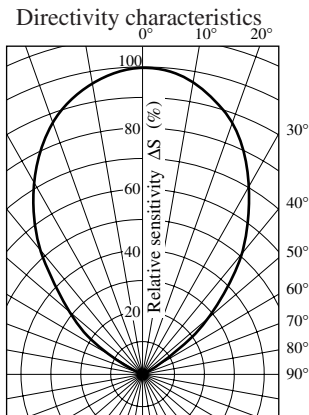
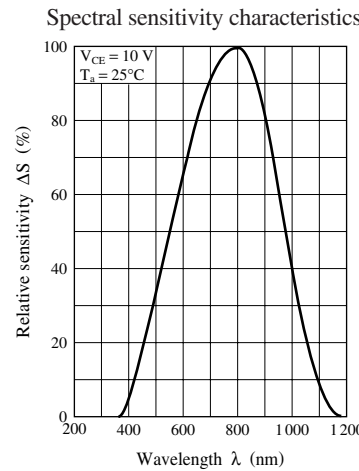
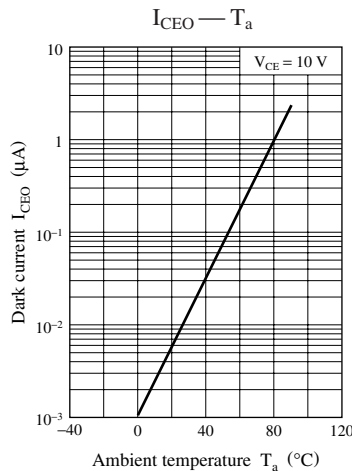
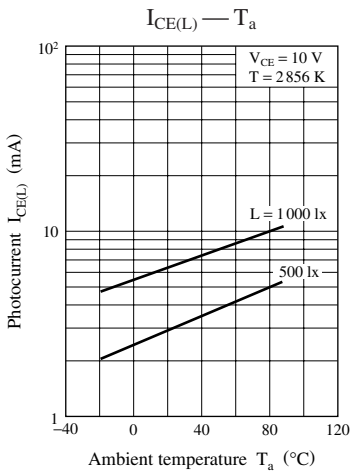
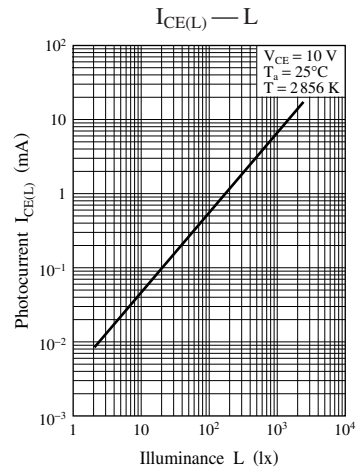
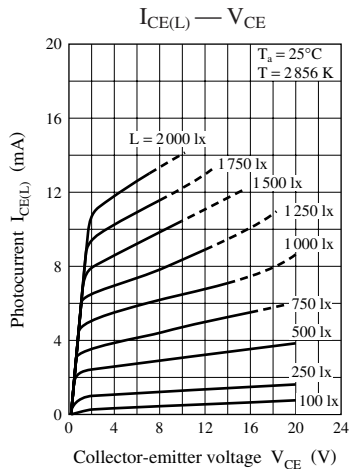
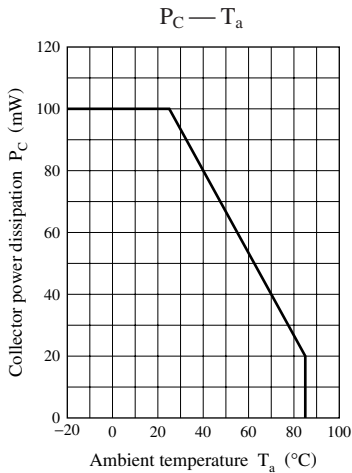
Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.

2. *1: Source: Tungsten (color temperature 2856 K)

*2: Switching time measurement circuit



Note) The part number in the parenthesis shows conventional part number.



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